

# **BZX585** series

# Voltage regulator diodes Rev. 5 — 11 October 2016

**Product data sheet** 

### **Product profile**

### 1.1 General description

General-purpose Zener diodes in an SOD523 (SC-79) ultra small and flat lead Surface-Mounted Device (SMD) plastic package.

### 1.2 Features and benefits

- Non-repetitive peak reverse power dissipation: ≤ 40 W
- Total power dissipation: ≤ 300 mW
- AEC-Q101 qualified

- Wide working voltage range: nominal 2.4 V to 75 V (E24 range)
- Two tolerance series: ±2 % and ±5 %
- Low differential resistance

### 1.3 Applications

General regulation functions

#### 1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{F}$	forward voltage	$I_F = 100 \text{ mA}$ [1]	-	-	1.1	V
P <sub>ZSM</sub>	non-repetitive peak reverse power dissipation	[2]	-	-	40	W

<sup>[1]</sup> Pulse test:  $t_p \le 300 \ \mu s$ ;  $\delta \le 0.02$ .

#### 2. **Pinning information**

Table 2. **Pinning** 

Pin	Description	Simplified outline	Graphic symbol
1	cathode [1]		
2	anode	1 2	1 2 006aaa152

[1] The marking bar indicates the cathode.



<sup>[2]</sup>  $t_p = 100 \mu s$ ; square wave;  $T_i = 25 \,^{\circ}C$  before surge

# 3. Ordering information

Table 3. Ordering information

Type number	Package						
	Name	Description	Version				
BZX585-B2V4 to BZX585-C75[1]	SC-79	plastic surface-mounted package; 2 leads	SOD523				

<sup>[1]</sup> The series consists of 74 types with nominal working voltages from 2.4 V to 75 V.

# 4. Marking

Table 4. Marking codes

Type number	Marking code						
BZX585-B2V4	C1	BZX585-B15	E0	BZX585-C2V4	F1	BZX585-C15	H0
BZX585-B2V7	C2	BZX585-B16	EA	BZX585-C2V7	F2	BZX585-C16	НА
BZX585-B3V0	C3	BZX585-B18	EB	BZX585-C3V0	F3	BZX585-C18	НВ
BZX585-B3V3	C4	BZX585-B20	EC	BZX585-C3V3	F4	BZX585-C20	HC
BZX585-B3V6	C5	BZX585-B22	ED	BZX585-C3V6	F5	BZX585-C22	HD
BZX585-B3V9	C6	BZX585-B24	EE	BZX585-C3V9	F6	BZX585-C24	HE
BZX585-B4V3	C7	BZX585-B27	EF	BZX585-C4V3	F7	BZX585-C27	HF
BZX585-B4V7	C8	BZX585-B30	EG	BZX585-C4V7	F8	BZX585-C30	HG
BZX585-B5V1	C9	BZX585-B33	EH	BZX585-C5V1	F9	BZX585-C33	НН
BZX585-B5V6	C0	BZX585-B36	EK	BZX585-C5V6	F0	BZX585-C36	HK
BZX585-B6V2	E1	BZX585-B39	EL	BZX585-C6V2	H1	BZX585-C39	HL
BZX585-B6V8	E2	BZX585-B43	EM	BZX585-C6V8	H2	BZX585-C43	НМ
BZX585-B7V5	E3	BZX585-B47	EN	BZX585-C7V5	H3	BZX585-C47	HN
BZX585-B8V2	E4	BZX585-B51	EP	BZX585-C8V2	H4	BZX585-C51	HP
BZX585-B9V1	E5	BZX585-B56	ER	BZX585-C9V1	H5	BZX585-C56	HR
BZX585-B10	E6	BZX585-B62	ES	BZX585-C10	H6	BZX585-C62	HS
BZX585-B11	E7	BZX585-B68	ET	BZX585-C11	H7	BZX585-C68	HT
BZX585-B12	E8	BZX585-B75	EU	BZX585-C12	H8	BZX585-C75	HU
BZX585-B13	E9	-	-	BZX585-C13	H9	-	-

# 5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
I <sub>F</sub>	forward current		-	200	mA
I <sub>ZSM</sub>	non-repetitive peak reverse current	[1]	-	see Table 8 and 9	
P <sub>ZSM</sub>	non-repetitive peak reverse power dissipation	[1]	-	40	W
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25  ^{\circ}C$	-	300	mW
T <sub>amb</sub>	ambient temperature		-65	+150	°C
Tj	junction temperature		-65	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

<sup>[1]</sup>  $t_p = 100 \mu s$ ; square wave;  $T_i = 25 \, ^{\circ}C$  before surge

### 6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air [1]	-	-	350	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point	[2]	-	-	65	K/W

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB) with approximately 35 mm<sup>2</sup> Cu area at cathode tab.

### 7. Characteristics

Table 7. Characteristics

 $T_i = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{F}$	forward voltage	[1]				
		I <sub>F</sub> = 10 mA	-	-	0.9	V
		I <sub>F</sub> = 100 mA	-	-	1.1	V

[1] Pulse test:  $t_p \leq 300~\mu s; \, \delta \leq 0.02.$ 

<sup>[2]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB) with approximately 35 mm<sup>2</sup> Cu area at cathode tab.

<sup>[2]</sup> Soldering point of cathode tab.

**Table 8.** Characteristics per type; BZX585-B2V4 to BZX585-C24  $T_j = 25$  °C unless otherwise specified.

BZX585- xxx	Sel	Worki voltag V <sub>Z</sub> (V)	e	Differential resistance $r_{dif}(\Omega)$		Reversion currer	nt		eratur icient ıV/K)	e	Diode capacitance C <sub>d</sub> (pF)[1]	Non-repetitive peak reverse current I <sub>ZSM</sub> (A)[2]		
		I <sub>Z</sub> = 5	mA	I <sub>Z</sub> = 1	$I_Z = 1 \text{ mA}$ $I_Z = 5 \text{ mA}$				I <sub>Z</sub> = 5 mA			_		
		Min	Max	Тур	Max	Тур	Max	Max	V <sub>R</sub> (V)	Min	Тур	Max	Max	Max
2V4	В	2.35	2.45	275	400	70	100	50	1	-3.5	-1.3	0	450	6
	С	2.28	2.52											
2V7	В	2.65	2.75	300	450	75	100	20	1	-3.5	-1.4	0	440	6
	С	2.57	2.84											
3V0	В	2.94	3.06	325	500	80	95	10	1	-3.5	-1.6	0	425	6
	С	2.85	3.15											
3V3	В	3.23	3.37	350	500	85	95	5	1	-3.5	-1.8	0	410	6
	С	3.14	3.47											
3V6	В	3.53	3.67	375	500	85	90	5	1	-3.5	-1.9	0	390	6
	С	3.42	3.78											
3V9	В	3.82	3.98	400	500	85	90	3	1	-3.5	-1.9	0	370	6
	С	3.71	4.10											
4V3	В	4.21	4.39	410	600	80	90	3	1	-3.5	-1.7	0	350	6
	С	4.09	4.52											
4V7	В	4.61	4.79	425	500	50	80	3	2	-3.5	-1.2	0.2	325	6
	С	4.47	4.94											
5V1	В	5.00	5.20	400	480	40	60	2	2	-2.7	-0.5	1.2	300	6
	С	4.85	5.36											
5V6	В	5.49	5.71	80	400	15	40	1	2	-2	1.0	2.5	275	6
	С	5.32	5.88											
6V2	В	6.08	6.32	40	150	6	10	3	4	0.4	2.2	3.7	250	6
	С	5.89	6.51											
6V8	В	6.66	6.94	30	80	6	15	2	4	1.2	3.0	4.5	215	6
	С	6.46	7.14											
7V5	В	7.35	7.65	15	80	2	10	1	5	2.5	3.6	5.3	170	4
	С	7.13	7.88											
8V2	В	8.04	8.36	20	80	2	10	0.7	5	3.2	4.3	6.2	150	4
	С	7.79	8.61											
9V1	В	8.92	9.28	20	100	2	10	0.5	6	3.8	5.2	7	120	3
	С	8.65	9.56											
10	В	9.80	10.20	20	150	2	10	0.2	7	4.5	6.0	8	110	3
	С	9.50	10.50											
11	В	10.78	11.22	25	150	2	10	0.1	8	5.4	6.9	9	110	2.5
	С	10.45	11.55											
12	В	11.76	12.24	25	150	2	10	0.1	8	6	7.9	10	105	2.5
	С	11.40	12.60											

BZX585\_SERIES

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Table 8. Characteristics per type; BZX585-B2V4 to BZX585-C24 ...continued

 $T_i = 25$  °C unless otherwise specified.

BZX585- xxx	Sel	Workii voltag V <sub>Z</sub> (V)	· dit (22)		nt	Temperature coefficient S <sub>Z</sub> (mV/K)			Diode capacitance C <sub>d</sub> (pF)[1]	Non-repetitive peak reverse current I <sub>ZSM</sub> (A)[2]				
		l <sub>Z</sub> = 5 ı	mA	I <sub>Z</sub> = 1	l mA	I <sub>Z</sub> = 5	mA			I <sub>Z</sub> = 5 mA			_	
		Min	Max	Тур	Max	Тур	Max	Max	V <sub>R</sub> (V)	Min	Тур	Max	Max	Max
13	В	12.74	13.26	25	170	2	10	0.1	8	7	8.8	11	105	2.5
	С	12.35	13.65											
15	В	14.70	15.30	25	200	3	15	0.05	10.5	9.2	10.7	13	100	2
	С	14.25	15.75											
16	В	15.68	16.32	50	200	10	40	0.05	11.2	10.4	12.4	14	90	1.5
	С	15.20	16.80											
18	В	17.64	18.36	50	225	10	45	0.05	12.6	12.4	14.4	16	80	1.5
	С	17.10	18.90											
20	В	19.60	20.40	60	225	15	55	0.05	14	14.4	16.4	18	70	1.5
	С	19.00	21.00											
22	В	21.56	22.44	60	250	20	55	0.05	15.4	16.4	18.4	20	60	1.25
	С	20.90	23.10											
24	В	23.52	24.48	60	250	25	70	0.05	16.8	18.4	20.4	22	55	1.25
	С	22.80	25.20											

<sup>[1]</sup>  $f = 1 \text{ MHz}; V_R = 0 \text{ V}$ 

<sup>[2]</sup>  $t_p = 100 \mu s$ ; square wave;  $T_i = 25 \, ^{\circ}C$  before surge

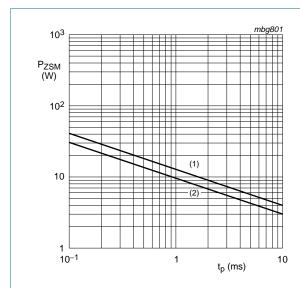
Table 9. Characteristics per type; BZX585-B27 to BZX585-C75

 $T_i = 25$  °C unless otherwise specified.

BZX585 -xxx	Sel	Workii voltag V <sub>Z</sub> (V)	•	Differ	rential 2)	resist	ance	Reverse current I <sub>R</sub> (μA)		Temperature coefficient S <sub>Z</sub> (mV/K)			Diode capacitance C <sub>d</sub> (pF) <sup>[1]</sup>	Non-repetitive peak reverse current I <sub>ZSM</sub> (A)[2]	
		l <sub>Z</sub> = 2 ı	πA	I <sub>Z</sub> = 0	.5 mA	I <sub>Z</sub> = 2	mA				mA		_		
		Min	Max	Тур	Max	Тур	Max	Max	V <sub>R</sub> (V)	Min	Тур	Max	Max	Мах	
27	В	26.46	27.54	65	300	25	80	0.05	18.9	21.4	23.4	25.3	50	1.0	
	С	25.65	28.35												
30	В	29.40	30.60	70	300	30	80	0.05	21	24.4	26.6	29.4	50	1.0	
	С	28.50	31.50												
33	В	32.34	33.66	75	325	35	80	0.05	23.1	27.4	29.7	33.4	45	0.9	
	С	31.35	34.65												
36	В	35.28	36.72	80	350	35	90	0.05	25.2	30.4	33.0	37.4	45	0.8	
	С	34.20	37.80												
39	В	38.22	39.78	80	350	40	130	0.05	27.3	33.4	36.4	41.2	45	0.7	
	С	37.05	40.95												
43	В	42.14	43.86	85	375	45	150	0.05	30.1	37.6	41.2	46.6	40	0.6	
	С	40.85	45.15												
47	В	46.06	47.94	85	375	50	170	0.05	32.9	42.0	46.1	51.8	40	0.5	
	С	44.65	49.35												
51	В	49.98	52.02	90	400	60	180	0.05	35.7	46.6	51.0	57.2	40	0.4	
	С	48.45	53.55												
56	В	54.88	57.12	100	425	70	200	0.05	39.2	52.2	57.0	63.8	40	0.3	
	С	53.20	58.80												
62	В	60.76	63.24	120	450	80	215	0.05	43.4	58.8	64.4	71.6	35	0.3	
	С	58.90	65.10												
68	В	66.64	69.36	150	475	90	240	0.05	47.6	65.6	71.7	79.8	35	0.25	
	С	64.60	71.40												
75	В	73.50	76.50	170	500	95	255	0.05	52.5	73.4	80.2	88.6	35	0.2	
	С	71.25	78.75												

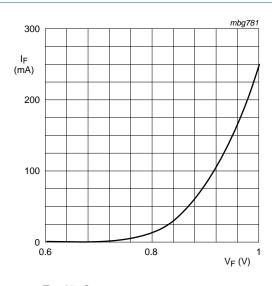
<sup>[1]</sup>  $f = 1 \text{ MHz}; V_R = 0 \text{ V}$ 

<sup>[2]</sup>  $t_p = 100 \mu s$ ; square wave;  $T_j = 25 \, ^{\circ}C$  before surge



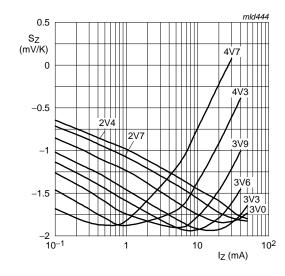
- (1)  $T_j = 25$  °C (before surge)
- (2)  $T_i = 150 \,^{\circ}\text{C}$  (before surge)

Fig 1. Non-repetitive peak reverse power dissipation as a function of pulse duration; maximum values



 $T_j = 25 \, ^{\circ}C$ 

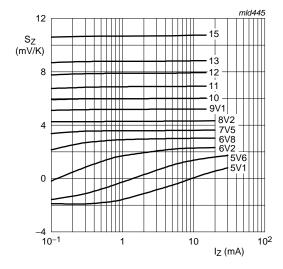
Fig 2. Forward current as a function of forward voltage; typical values



BZX585-B/C2V4 to BZX585-B/C4V7

 $T_i = 25 \,^{\circ}\text{C}$  to 150  $^{\circ}\text{C}$ 

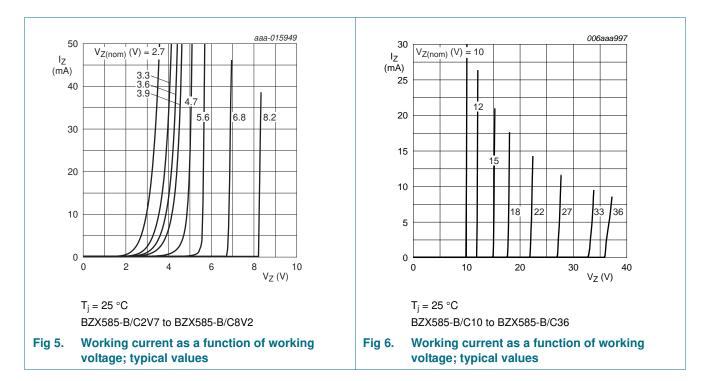
Fig 3. Temperature coefficient as a function of working current; typical values



BZX585-B/C5V1 to BZX585-B/C15

 $T_i = 25 \,^{\circ}\text{C}$  to 150  $^{\circ}\text{C}$ 

Fig 4. Temperature coefficient as a function of working current; typical values

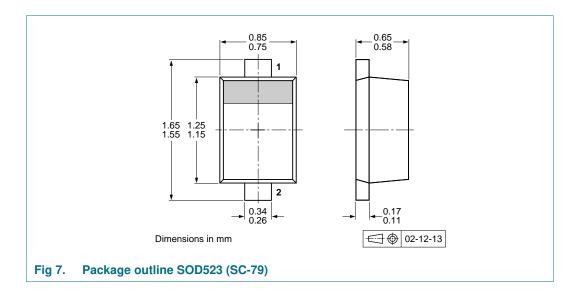


### 8. Test information

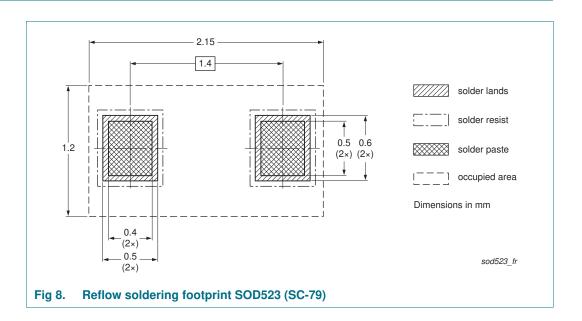
### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

# 9. Package outline



# 10. Soldering



# 11. Revision history

### Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes							
BZX585_SER v.5	20161011	Product data sheet	-	BZX585_SER v.4							
Modifications:		<ul> <li>The format of this document has been redesigned to comply with the new identity guidelines of NXP Semiconductors</li> </ul>									
	<ul> <li>Legal texts l</li> </ul>	nave been adapted to the ne	ew company name wh	ere appropriate.							
	Section 1 "P	roduct profile": enhanced.									
	• <u>Table 5</u> : T <sub>am</sub>	<sub>b</sub> added.									
	• Table 8 and	Table 9: updated									
	• Figure 1, Fig	gure 5 and Figure 6: added									
	Section 8 "T	est information": added.									
	• <u>Figure 7</u> : rep	placed by minimized packag	e outline								
	• <u>Section 10 "</u>	Soldering": added									
	• <u>Section 12</u> "	Legal information": updated									
BZX585_SER v.4	20040622	20040622 Product data sheet - BZX585_SER v.3									
BZX585_SER v.3	20040326	20040326 Product specification - BZX585_SER v.2									
BZX585_SER v.2	20001020	Product specification	-	BZX585_SER v.1							
BZX585_SER v.1	20000606	20000606 Product specification									

### 12. Legal information

#### 12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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BZX585 SERIES

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# **BZX585** series

# **Nexperia**

Voltage regulator diodes

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